

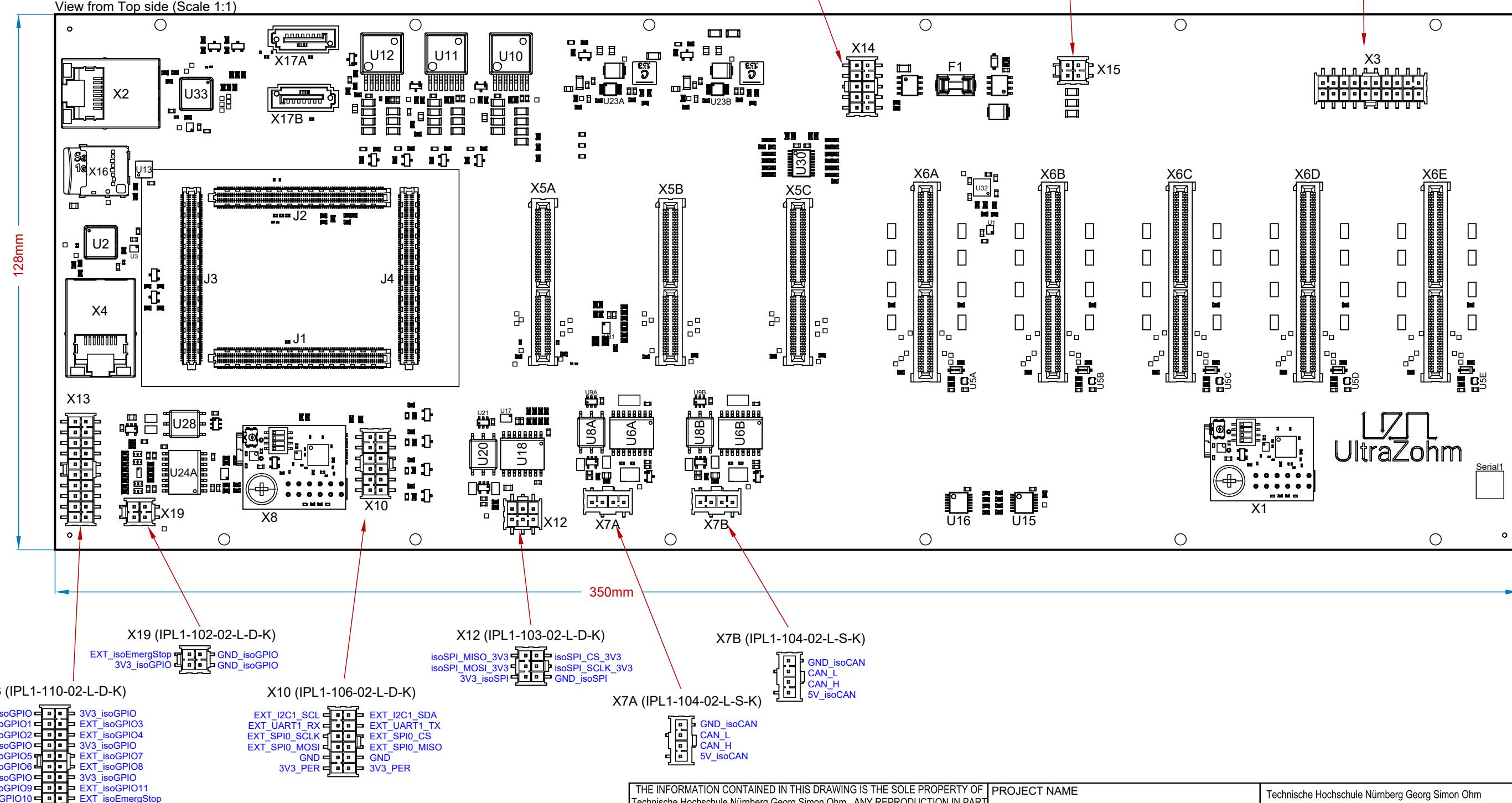
A

B

C

D

View from Top side (Scale 1:1)



THE INFORMATION CONTAINED IN THIS DRAWING IS THE SOLE PROPERTY OF
Technische Hochschule Nürnberg Georg Simon Ohm. ANY REPRODUCTION IN PART
OR AS A WHOLE WITHOUT THE WRITTEN PERMISSION OF Technische Hochschule
Nürnberg Georg Simon Ohm IS PROHIBITED.

PROPRIETARY AND CONFIDENTIAL

PROJECT NAME
UltraZohm Carrier Board
REVISION 04

Technische Hochschule Nürnberg Georg Simon Ohm
Wassertorstr. 10
90489 Nürnberg
GERMANY



ENGINEER Andreas Geiger

SCALE: 1:1 DATE 27.04.2021

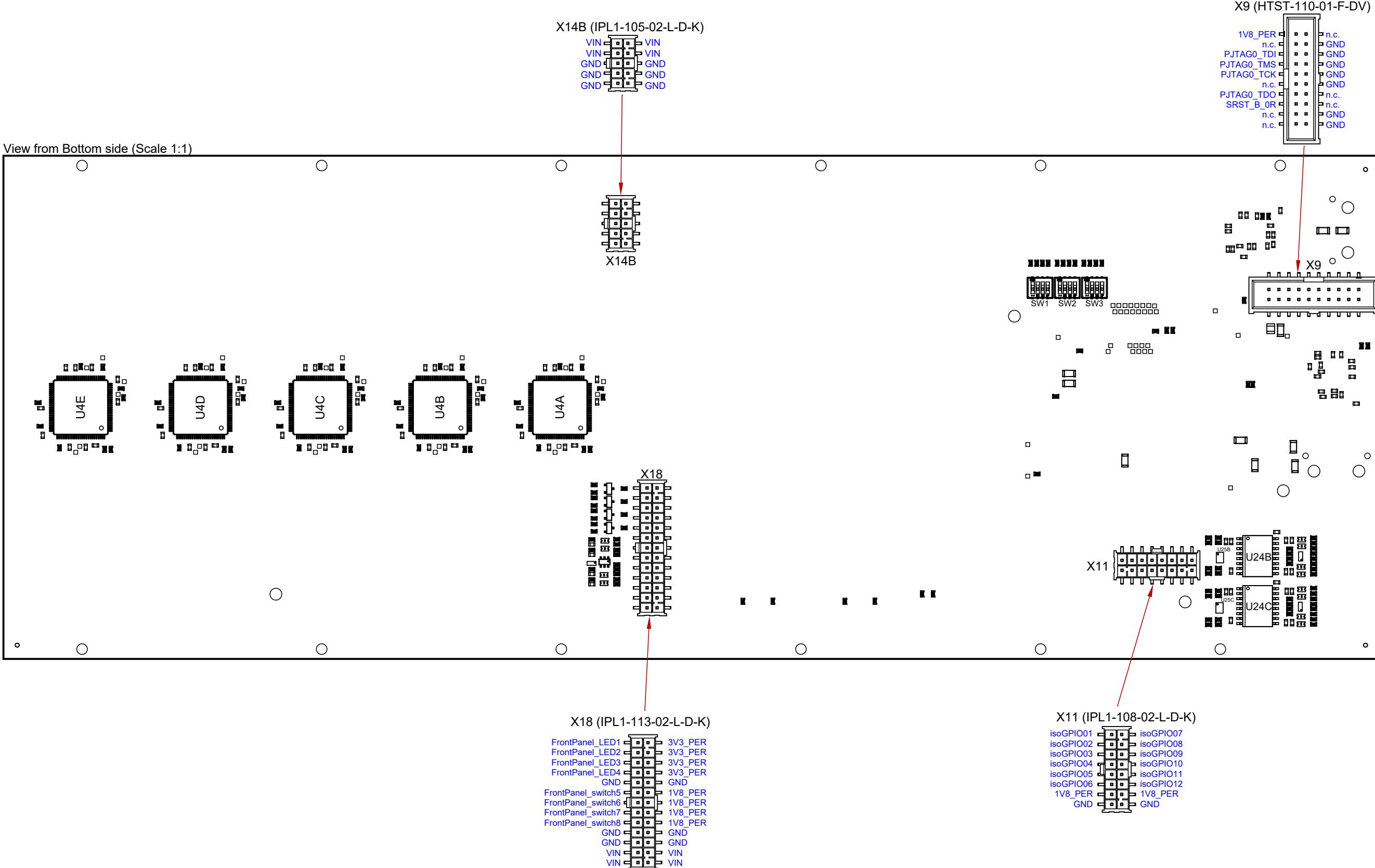
SHEET 1 OF 4

A

B

C

D



THE INFORMATION CONTAINED IN THIS DRAWING IS THE SOLE PROPERTY OF
Technische Hochschule Nürnberg Georg Simon Ohm. ANY REPRODUCTION IN PART
OR AS A WHOLE WITHOUT THE WRITTEN PERMISSION OF Technische Hochschule
Nürnberg Georg Simon Ohm IS PROHIBITED.

PROPRIETARY AND CONFIDENTIAL

PROJECT NAME
UltraZohm Carrier Board
REVISION 04

Technische Hochschule Nürnberg Georg Simon Ohm
Wassertorstr. 10
90489 Nürnberg
GERMANY



ENGINEER Andreas Geiger

SCALE: 1:1 DATE 27.04.2021

SHEET 2 OF 4

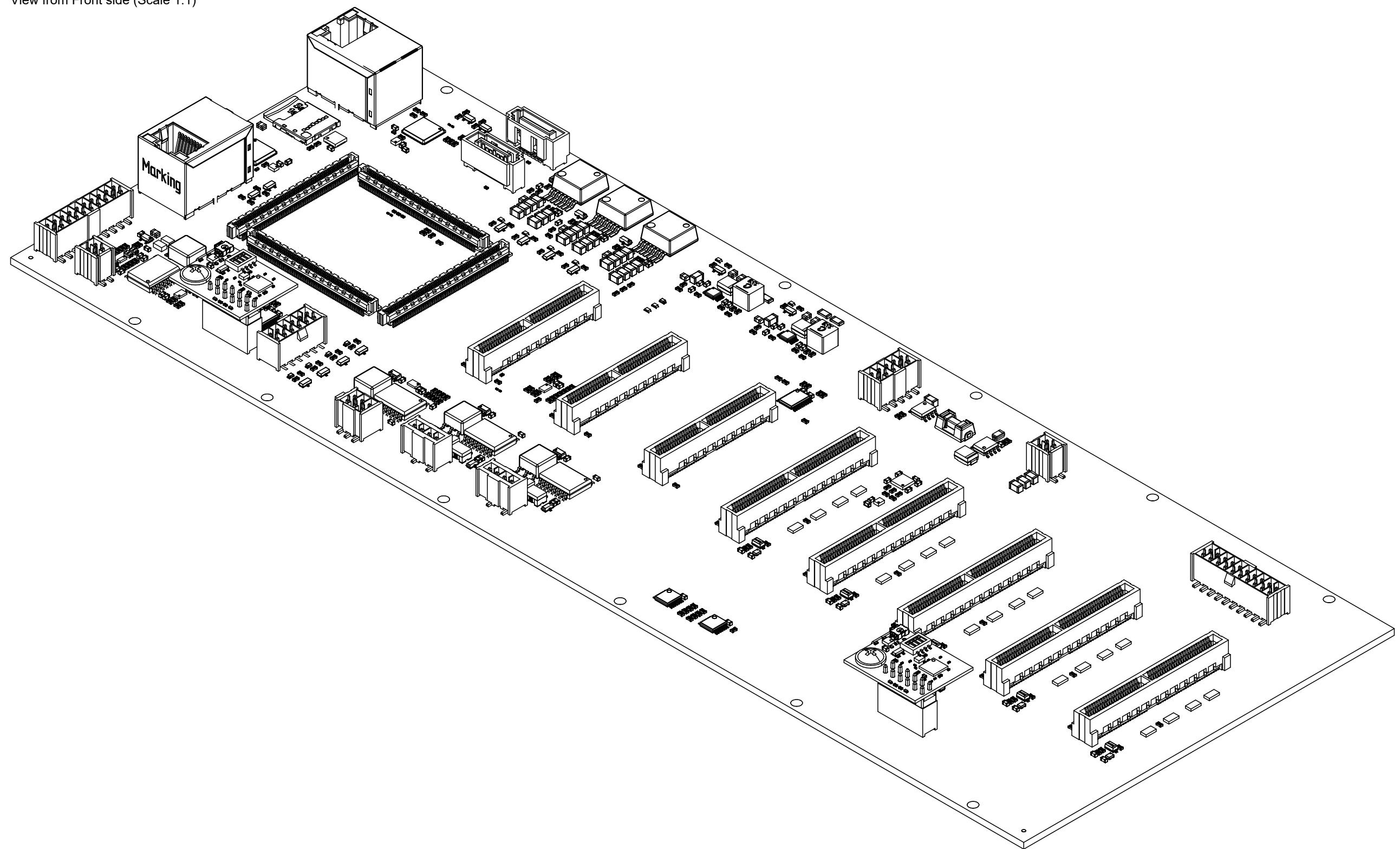
A

B

C

D

View from Front side (Scale 1:1)



THE INFORMATION CONTAINED IN THIS DRAWING IS THE SOLE PROPERTY OF
Technische Hochschule Nürnberg Georg Simon Ohm. ANY REPRODUCTION IN PART
OR AS A WHOLE WITHOUT THE WRITTEN PERMISSION OF Technische Hochschule
Nürnberg Georg Simon Ohm IS PROHIBITED.

PROPRIETARY AND CONFIDENTIAL

PROJECT NAME
UltraZohm Carrier Board
REVISION 04

ENGINEER Andreas Geiger

Technische Hochschule Nürnberg Georg Simon Ohm
Wassertorstr. 10
90489 Nürnberg
GERMANY



SHEET 3 OF 4

A

B

C

D

A

B

C

D

Layer Stack Legend

	Material	Layer	Thickness	Dielectric Material	Type	Gerber Legend
	Surface Material	Top Overlay				GTO
	Copper	Top Solder	0.010mm	Solder Resist	Solder Mask	GTS
	Prepreg	Top Layer	0.035mm		Signal	GTL
1	Copper	L02_GND	0.140mm	FR-4	Dielectric	
	Core		0.300mm	FR-4	Dielectric	
	Copper	L03_Sig	0.018mm		Signal	G1
	Core		1.000mm	FR-4	Dielectric	
	Copper	L04_Sig	0.018mm		Signal	G2
	Core		0.300mm	FR-4	Dielectric	
	Copper	L05_VCC	0.018mm		Signal	G3
	Prepreg		0.140mm	FR-4	Dielectric	
	Copper	Bottom Layer	0.035mm		Signal	GBL
	Surface Material	Bottom Solder	0.010mm	Solder Resist	Solder Mask	GBS
		Bottom Overlay			Legend	GBO

Total thickness: 2.041mm

Drill Table

Symbol	Count	Hole Size	Plated	Hole Tolerance
△	1723	0.200mm	Plated	None
□	876	0.300mm	Plated	None
☆	20	0.890mm	Plated	None
□	24	1.000mm	Plated	None
◇	8	1.020mm	Plated	None
◇	16	1.270mm	Non-Plated	None
☆	4	1.350mm	Plated	None
⊕	4	1.630mm	Plated	None
☆	12	2.900mm	Plated	None
○	4	3.200mm	Plated	None
⊗	4	3.200mm	Non-Plated	None
2695 Total				

THE INFORMATION CONTAINED IN THIS DRAWING IS THE SOLE PROPERTY OF
 Technische Hochschule Nürnberg Georg Simon Ohm. ANY REPRODUCTION IN PART
 OR AS A WHOLE WITHOUT THE WRITTEN PERMISSION OF Technische Hochschule
 Nürnberg Georg Simon Ohm IS PROHIBITED.

PROPRIETARY AND CONFIDENTIAL

PROJECT NAME

UltraZohm Carrier Board

REVISION 04

 Technische Hochschule Nürnberg Georg Simon Ohm
 Wassertorstr. 10
 90489 Nürnberg
 GERMANY


ENGINEER Andreas Geiger

SCALE: 1:1 DATE 27.04.2021

SHEET 4 OF 4